

#### **General Description**

The MAX3274/MAX3276\* dual-rate Fibre Channel limiting amplifiers are optimized for use in dual-rate 2.125Gbps/1.0625Gbps Fibre Channel optical receiver systems. An on-chip selectable fourth-order Bessel Thompson filter offers 15dB (typ) of attenuation at 2GHz to suppress the relaxation oscillation (RO) found in legacy transmitters. The amplifiers accept a wide range of input voltages and provide constant-level output voltages with controlled edge speeds. Receivers using the MAX3275/MAX3277 transimpedance amplifiers (TIA) and the MAX3274/MAX3276 dual-rate limiting amplifiers can meet the Fibre Channel receiver sensitivity optical modulation amplitude (OMA) specification of 49mW<sub>P-P</sub> at 2.125Gbps and 31mWp-p at 1.0625Gbps. Additional features include a programmable threshold loss-ofsignal (LOS) detector, output squelch, and bandwidth select. The MAX3274/MAX3276 feature current-mode logic (CML) data outputs. The MAX3274/MAX3276 are available in 16-pin QFN packages, making them ideal for GBIC and small form-factor receiver modules.

#### **Applications**

Fibre Channel GBIC Optical Modules Dual-Rate Fibre Channel SFF/SFP Optical Modules

#### **Features**

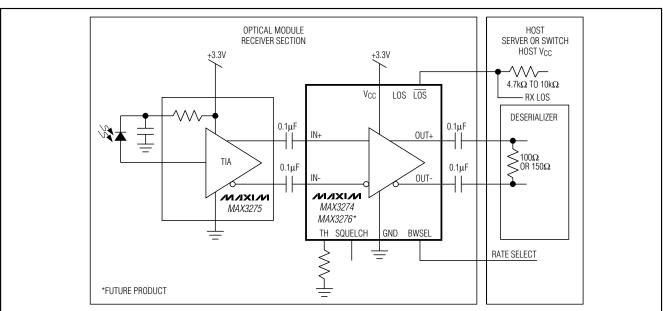
- ♦ Dual-Rate 1.0625Gbps/2.125Gbps Operation
- ♦ On-Chip Selectable 4th-Order Filter
- ♦ Relaxation Oscillation Suppression of Legacy, **CD Laser-Based Transmitters**
- ♦ Available in 100 $\Omega$  and 150 $\Omega$  Output Terminations
- ♦ Programmable Loss-of-Signal (LOS) Threshold
- **♦ Output Squelch Control**
- ♦ Power-On Reset Minimizes Inrush Current
- ♦ 4mm × 4mm 16-Pin QFN Packages

#### **Ordering Information**

PART	TEMP RANGE	DIFF OUTPUT TERMINATION		
MAX3274UGE	0°C to +85°C	100Ω	16 QFN	
<b>MAX3276</b> UGE*	0°C to +85°C	$150\Omega$	16 QFN	

<sup>\*</sup>Future product—contact factory for availability

### **Typical Operating Circuit**



Pin Configurations appear at end of data sheet.

MIXIM

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<sup>\*</sup>Future product

#### **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage (VCC)	0.5V to +6.0V
Continuous CML Output Current	
(OUT+, OUT-)	25mA to +25mA
CML Input Voltage (IN+, IN-)	0.5V to (V <sub>CC</sub> + 0.5V)
Differential Input Voltage (IN+, IN-)	2V <sub>P-P</sub>
TTL Input Voltage	
(BWSEL, SQUELCH, TEST)	0.5V to $(V_{CC} + 0.5V)$

Voltage at TH	
Open Collector (LOS, LOS) Operating Ambient Temperature Range	0.5V to +5.5V
Storage Ambient Temperature Range	55°C to +100°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = +3.0 \text{V to } +3.6 \text{V}, T_A = 0 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}. \text{ Typical values are at } V_{CC} = +3.3 \text{V and } T_A = +25 ^{\circ}\text{C}, \text{ unless otherwise noted.})$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Current				78	99	mA
Data Rate		BWSEL = 0		1.0625		Gbps
		BWSEL = 1		2.125		
Small-Signal Bandwidth		-3dB, BWSEL = 0 (Note 1)	0.77	0.89	1.0	GHz
		-15dB, BWSEL = 0 (Note 1)			2.0	
		-3dB, BWSEL = 1 (Note 1)		1.7		
BWSEL Response Time		(Note 2)			10	μs
Input Range	V <sub>IN</sub>	(Notes 2, 3)	10		1200	mV <sub>P-P</sub>
		BWSEL = 0, 10mV ≤ input ≤ 20mV (Notes 2, 4)		44	61	psp-p
Deterministic Jitter		BWSEL = 0, 20mV < input ≤ 1200mV (Notes 2, 4)		37	44	
		BWSEL = 1, 10mV ≤ input ≤ 1200mV (Notes 2, 4)		10	20	
Random Jitter		BWSEL = 0 (Notes 2, 5)		6.1		000140
naridom sitter		BWSEL = 1 (Notes 2, 5)		3.8		psrms
Total Jitter		BWSEL = 0 (Note 6)		130		psp-p
Total Jitter		BWSEL = 1 (Note 6)		63		
LOS, LOS Transition Time		10% to 90% rise/fall time (Notes 2, 7)	5		350	ns
LOS, LOS Response Time		Figure 1 (Note 2)	1		20	μs
LOS, TOS Hysteresis		20 × log (VDEASSERT/VASSERT), VTH = 6mVp-p (Note 8)	2		8	dB
		V <sub>TH</sub> = 30mV <sub>P-P</sub> (Notes 2, 8)	4		8	
LOS Assert (V <sub>LOS</sub> ) Range		$330\Omega$ < R <sub>TH</sub> < 2.0k $\Omega$ (Notes 2, 8)	8		30	mV
LOS Assert (V <sub>LOS</sub> ) Error		$330\Omega$ < R <sub>TH</sub> < 2.0kΩ (Notes 2, 8)	-30		+30	%
Squelch Input Current					100	μΑ
Single-Ended Input Resistance	RIN	IN+, IN- to V <sub>CC</sub>	40	50	60	Ω
Data Input VSWR		f < 2GHz (Note 2)			2.5	
Differential Output Resistance	Rout	OUT+ to OUT- (MAX3274)	80	100	120	Ω
		OUT+ to OUT- (MAX3276)	120	150	180	Ω
CML Output Voltage	M	SQUELCH = 0 (Note 4)	900	1200	1600	mV <sub>P-P</sub>
	Vout	SQUELCH = 1, V <sub>IN</sub> < V <sub>TH</sub> (Note 4)			30	
Data Output Levels		SQUELCH = 1, V <sub>IN</sub> < V <sub>TH</sub> (Note 4)	V <sub>CC</sub> - 0.1		Vcc	V

#### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{CC} = +3.0V \text{ to } +3.6V, T_A = 0^{\circ}\text{C to } +85^{\circ}\text{C}. \text{ Typical values are at } V_{CC} = +3.3V \text{ and } T_A = +25^{\circ}\text{C}, \text{ unless otherwise noted.})$ 

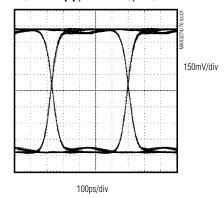
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Data Outrant Educ Coasad		20% to 80%, BWSEL = 0 (Notes 2, 5)		170	220	psp-p
Data Output Edge Speed		20% to 80%, BWSEL = 1 (Notes 2, 5)		105	140	
		LOS asserted	1.0			mA
LOS Current Sink		LOS not asserted, $V_{CC}$ = 0, 4.7k $\Omega$ pullup to +5.5V	0		10	μΑ
LOS Current Sink		LOS not asserted	1.0			mA
LOS Current Sink		LOS asserted, $V_{CC} = 0$ , $4.7k\Omega$ pullup to $+5.5V$	0		10	μΑ
LOS, LOS Output Low Voltage		LOS, LOS sink current = 1mA			0.5	V
Supply Noise Tolerance		10kHz ≤ f < 1MHz (Note 9)		40	•	m\/= =
Supply Noise Tolerance		1MHz ≤ f < 50MHz (Note 9)		20	•	mV <sub>P-P</sub>

- **Note 1:** Measured with a  $\leq$  -50dBm input signal on a network analyzer.
- Note 2: Specifications are guaranteed by design and characterization.
- Note 3: Using 27 1 PRBS pattern. The input bandwidth is limited to 0.75 × (selected data rate) by a 4th-order Bessel Thompson filter.
- Note 4: Using a K28.5 pattern at the selected bit rate. Measured differentially into a matched external load.
- Note 5: Using a K28.7 or equivalent pattern at the selected bit rate. Measured over the entire input voltage range.
- Note 6: Total jitter is estimated as TJ = DJ + 14 x RJ, where DJ is the peak-to-peak deterministic jitter, and RJ is the RMS random jitter.
- **Note 7:** LOS (open collector) is connected to a +5.5V supply through a 4.7k $\Omega$  external resistor.
- Note 8: Using K28.7 or equivalent pattern at selected bit rate.
- Note 9: Total jitter, deterministic jitter, LOS hysteresis, LOS assert performance verified.

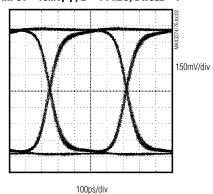
### **Typical Operating Characteristics**

 $\overline{(V_{CC} = +3.3V, T_A = +25^{\circ}C, \text{ unless otherwise noted.})}$ 

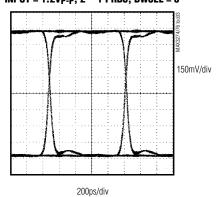
 $INPUT = 1.2V_{P-P}$ ,  $2^7 - 1$  PRBS, BWSEL = 1



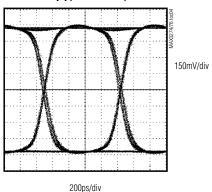
INPUT = 10mV<sub>P-P</sub>, 2<sup>7</sup> - 1 PRBS, BWSEL = 1



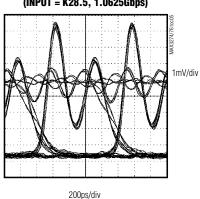
INPUT =  $1.2V_{P-P}$ ,  $2^7 - 1$  PRBS, BWSEL = 0



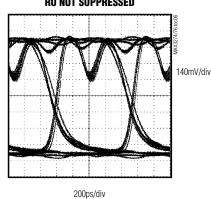
 $INPUT = 10mV_{P-P}$ ,  $2^7 - 1$  PRBS, BWSEL = 0



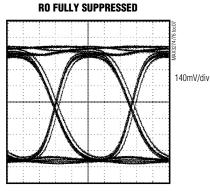
INPUT RELAXATION OSCILLATION (RO) OF LEGACY FIBRE CHANNEL TRANSMITTERS (INPUT = K28.5, 1.0625Gbps)



BWSEL = 1 Ro not suppressed



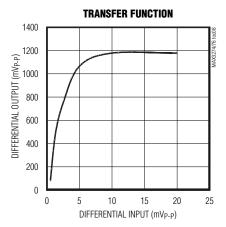
BWSEL = 0

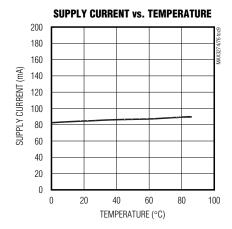


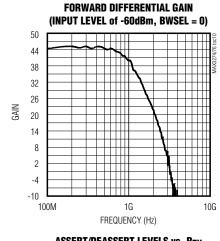
v 200ps/div

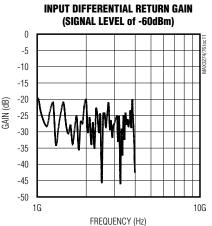
### **Typical Operating Characteristics (continued)**

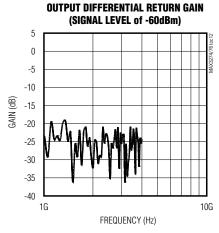
 $(V_{CC} = +3.3V, T_A = +25^{\circ}C, \text{ unless otherwise noted.})$ 

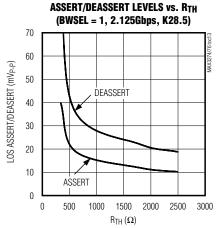


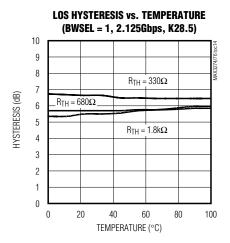


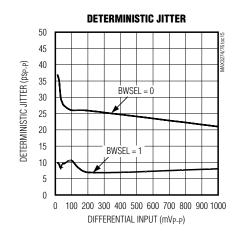


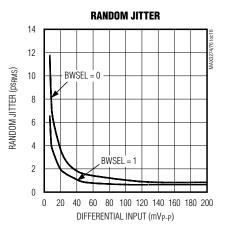












## Pin Description

PIN	NAME	FUNCTION	
1	IN+	Noninverted Data Input	
2	IN-	Inverted Data Input	
3, 7, 10	Vcc	Supply Voltage	
4	BWSEL	Bandwidth Select Pin. When BWSEL is set to a TTL-low level or left open, a 4th-order Bessel Thompson filter suppresses relaxation oscillations from legacy CD laser transmitters. Connect BWSEL to a TTL-high for operation above 1.0625Gbps.	
5	TEST	Test Pin Should Be Connected to Ground	
6	SQUELCH	Squelch Input. The squelch function is disabled when SQUELCH is set to a TTL-low. When SQUELCH is set to a TTL-high level, and LOS is asserted, the data outputs (OUT+ and OUT-) are forced to static levels.	
8, 13, 16	GND	Supply Ground	
9	TH	Loss-of-Signal Threshold. A resistor connected from this pin to ground sets the input signal level at which the loss-of-signal (LOS) outputs are asserted. See the <i>Typical Operating Characteristics</i> and <i>Design Procedure</i> sections for more information.	
11	OUT-	Inverted Data Output	
12	OUT+	Noninverted Data Output	
14	LOS	Inverted Loss-of-Signal Output. $\overline{\text{LOS}}$ is high when the level of the input signal is above the preset threshold set by the TH pin. $\overline{\text{LOS}}$ is asserted low when the input signal level drops below the threshold.	
15	LOS	Loss-of-Signal Output. LOS is low when the level of the input signal is above the preset threshold set by the TH pin. LOS is asserted high when the input signal level drops below the threshold.	
EP	Exposed Pad	Ground. The exposed paddle must be soldered to the circuit board ground for proper thermal and electrical performance.	

#### **Detailed Description**

Figure 2 is a functional diagram of the MAX3274/ MAX3276 limiting amplifiers. Typical gain is 46dB. A linear input drives a bandwidth selector. An offset correction loop with lowpass filtering ensures low deterministic jitter. An integrated RMS signal detector monitors for loss-of-signal conditions. The output buffer provides a limited CML output signal.

#### **Input Buffer**

The MAX3274/MAX3276 input buffer (Figure 3) provides a  $100\Omega$  input impedance between IN+ and IN-. DC-coupling the inputs is not recommended; doing so prevents proper functioning of DC offset correction circuitry.

#### Signal Detect and Loss-of-Signal

An RMS signal detector looks at the signal from the input buffer and compares it to a threshold set by a resistor at pin TH. The status of the signal-detect information appears at the LOS outputs. These are open-collector outputs and require external pullup resistors connected to the host power supply. The LOS outputs are high impedance when the power supply to the MAX3274/MAX3276 is 0V. ESD protection on the dual-rate limiting amplifiers' LOS outputs do not forward-bias when the power supply of the MAX3274/MAX3276 is 0V or below the host power supply.

#### **Offset Correction**

A low-frequency feedback loop is integrated into the limiting amplifiers to reduce input offset and thereby minimize duty-cycle distortion. For proper operation, the input must be externally AC-coupled. The offset correction circuit has been optimized for the Fibre Channel character set, disparity rules, and 8b/10b data encoding. This dictates an average data input mark density of 50% and a maximum run length of five consecutive identical digits (CID) or bits.

#### **CML Output Buffer**

The MAX3274/MAX3276 CML outputs (Figure 4) provide high tolerance to impedance mismatches and inductive connectors. The output current is approximately 24mA for the MAX3274 and 18mA for the MAX3276. The squelch function is enabled when SQUELCH is set to a TTL-high level or connected to Vcc. The squelch function holds OUT+ and OUT- at a static voltage when the input signal level drops below the loss-of-signal threshold. The output buffer can be AC- or DC-coupled to the load. For DC operation, the load must be terminated to Vcc of the MAX3274/MAX3276.

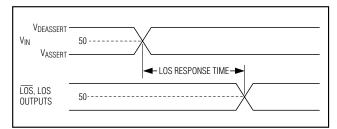


Figure 1. LOS Response Time

#### **Design Procedure**

#### **Programming the LOS Assert Threshold**

External resistor R<sub>TH</sub> programs the loss-of-signal threshold. See the LOS Threshold vs. R<sub>TH</sub> graph in the *Typical Operating Characteristics* section. R<sub>TH</sub> can be estimated by R<sub>TH</sub> = 15 / V<sub>TH</sub>, where V<sub>TH</sub> is the peak-to-peak differential input assert level.

#### **Selecting the AC-Coupling Capacitors**

The input and output AC-coupling capacitors (C<sub>IN</sub>, C<sub>OUT</sub>) should be selected to minimize the receiver's deterministic jitter. Lowering the low-frequency cutoff reduces deterministic jitter. The low-frequency cutoff can be determined by:

$$f_C = \frac{1}{2\pi \times C \times (R_L + R_S)}$$

where  $R_L$  is the single-ended load impedance and  $R_S$  is the single-ended source impedance.  $C_{IN}$ ,  $C_{OUT}$  = 0.1 $\mu F$  is recommended.

### **Applications Information**

#### **Optical Hysteresis**

In an optical receiver, the electrical power change at the limiting amplifier is 2 times the optical power change. For example, if a receiver's optical input power  $(\chi)$  increases by a factor of 2, and the preamplifier is linear, then the voltage input to the limiting amplifier also increases by a factor of 2. The optical power change is  $10\log(2\chi/\chi) = 10\log(2) = 3dB$ . At the limiting amplifier, the electrical power change is:

$$10\log \frac{(2V_{IN})^2/R_{IN}}{V_{IN}^2/R_{IN}} = 10\log (2^2) = 20\log (2) = 6dB$$

The typical voltage hysteresis for the MAX3274/ MAX3276 is 6dB. This provides an optical hysteresis of 3dB.

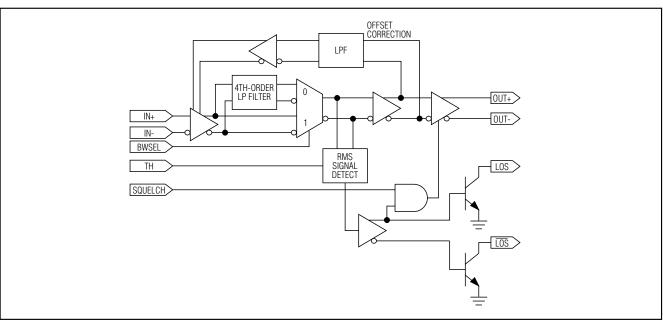


Figure 2. Functional Diagram of the MAX3274/MAX3276 Limiting Amplifier

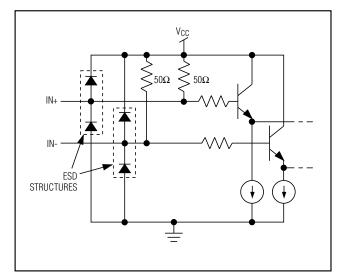


Figure 3. Input Circuit

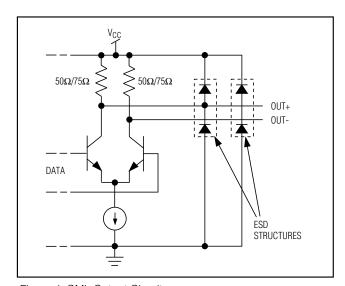
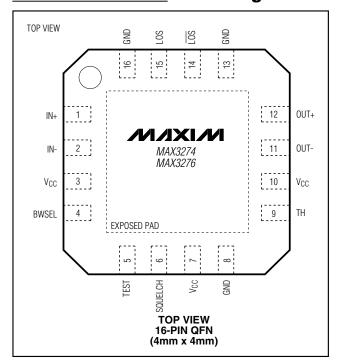


Figure 4. CML Output Circuit

### **Pin Configuration**

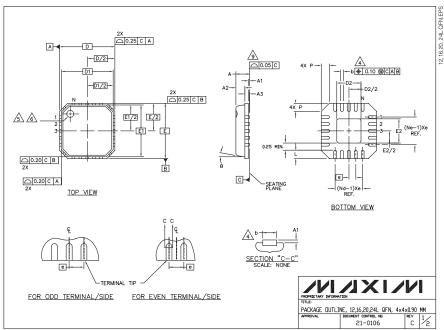


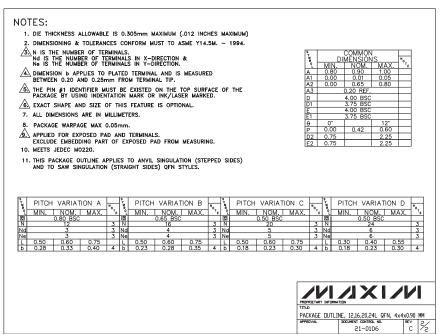
### \_Chip Information

DEVICE COUNT: 2855
TRANSISTOR COUNT: 1310
PROCESS: BiPOLAR: SiGe, SOI

#### Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)





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